

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

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Title of Invention	Homogeneous Copper Interconnects for BEOL																																																																																																														
<p>Application Number :</p> <p>Confirmation Number:</p> <p>First Named Applicant: Kevin Petrarca</p> <p>Attorney Docket Number: FIS920040258US1</p> <p>Art Unit:</p> <p>Examiner:</p> <p>Search string: (6709562 or 6380628 or 6339258 or 6337151 or 6743719 or 6472023 or 6680514 or 6071814 or 6136707 or 6174799 or 6368961 or 6726535 or 20040021226 or 20020027082).pn</p>																																																																																																															
<h2>US Patent Documents</h2> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td>THN</td><td>1</td><td>6709562</td><td>2004-03-23</td><td>ANDRICACOS, ET AL.</td><td></td><td></td><td></td></tr><tr><td>THN</td><td>2</td><td>6380628</td><td>2002-04-30</td><td>MILLER, ET AL.</td><td></td><td></td><td></td></tr><tr><td>THN</td><td>3</td><td>6339258</td><td>2002-01-15</td><td>COONEY, III, ET AL.</td><td></td><td></td><td></td></tr><tr><td>THN</td><td>4</td><td>6337151</td><td>2002-01-08</td><td>UZOH, ET AL.</td><td></td><td></td><td></td></tr><tr><td>THN</td><td>5</td><td>6743719</td><td>2004-06-01</td><td>CHEN, ET AL.</td><td></td><td></td><td></td></tr><tr><td>THN</td><td>6</td><td>6472023</td><td>2002-10-29</td><td>WU, ET AL.</td><td></td><td></td><td></td></tr><tr><td>THN</td><td>7</td><td>6680514</td><td>2004-01-20</td><td>GEFFKEN, ET AL.</td><td></td><td></td><td></td></tr><tr><td>THN</td><td>8</td><td>6071814</td><td>2000-06-06</td><td>JANG</td><td></td><td></td><td></td></tr><tr><td>THN</td><td>9</td><td>6136707</td><td>2000-10-24</td><td>COHEN</td><td></td><td></td><td></td></tr><tr><td>THN</td><td>10</td><td>6174799</td><td>2001-01-16</td><td>LOPATIN, ET AL.</td><td></td><td></td><td></td></tr><tr><td>THN</td><td>11</td><td>6368961</td><td>2002-04-09</td><td>LOPATIN, ET AL.</td><td></td><td></td><td></td></tr><tr><td>THN</td><td>12</td><td>6726535</td><td>2004-04-27</td><td>SHIH, ET AL.</td><td></td><td></td><td></td></tr></tbody></table>								init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass	THN	1	6709562	2004-03-23	ANDRICACOS, ET AL.				THN	2	6380628	2002-04-30	MILLER, ET AL.				THN	3	6339258	2002-01-15	COONEY, III, ET AL.				THN	4	6337151	2002-01-08	UZOH, ET AL.				THN	5	6743719	2004-06-01	CHEN, ET AL.				THN	6	6472023	2002-10-29	WU, ET AL.				THN	7	6680514	2004-01-20	GEFFKEN, ET AL.				THN	8	6071814	2000-06-06	JANG				THN	9	6136707	2000-10-24	COHEN				THN	10	6174799	2001-01-16	LOPATIN, ET AL.				THN	11	6368961	2002-04-09	LOPATIN, ET AL.				THN	12	6726535	2004-04-27	SHIH, ET AL.			
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THN	1	20040021226	2004-02-05	GEFFKEN, ET AL.			
THN	2	20020027082	2002-03-07	ANDRICACOS, ET AL			

Signature

Examiner Name	Date
<i>William G. Zylman</i>	<i>12/29/05</i>